AUTOMOTIVE

RoHS

HALOGEN

FREE

**GREEN** 



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## Vishay Semiconductors

# High Speed Infrared Emitting Diode, 940 nm, GaAlAs Double Hetero



#### **DESCRIPTION**

VSMB1940ITX01 is an infrared, 940 nm emitting diode in GaAlAs double hetero technology with high radiant power and high speed, molded in clear, untinted 0805 plastic package for surface mounting (SMD).

#### **FEATURES**

- · Package type: surface mount
- Package form: 0805
- Dimensions (L x W x H in mm): 2 x 1.25 x 0.85
- AEC-Q101 qualified
- Enhanced operating temperature range: -40 °C to +105 °C
- Peak wavelength: λ<sub>p</sub> = 940 nm
- High reliability
- High radiant power
- · High radiant intensity
- High speed
- Angle of half sensitivity:  $\varphi = \pm 60^{\circ}$
- Low forward voltage
- Suitable for high pulse current operation
- 0805 standard surface-mountable package
- Floor life: 72 h, MSL 4, according to J-STD-020
- Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **APPLICATIONS**

- IR emitter for automotive applications
- High power emitter for low space applications
- High performance transmissive or reflective sensors

PRODUCT SUMMARY				
COMPONENT	I <sub>e</sub> (mW/sr)	φ (deg)	λ <sub>p</sub> (nm)	t <sub>r</sub> (ns)
VSMB1940ITX01	6	± 60	940	15

#### Note

• Test conditions see table "Basic Characteristics"

ORDERING INFORMATION						
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM			
VSMB1940ITX01	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	0805			

#### Note

• MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T <sub>amb</sub> = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		$V_R$	5	V	
Forward current		I <sub>F</sub>	100	mA	
Peak forward current	$t_p/T = 0.5, t_p = 100 \mu s$	I <sub>FM</sub>	200	mA	
Surge forward current	t <sub>p</sub> = 100 μs	I <sub>FSM</sub>	1	Α	
Power dissipation		P <sub>V</sub>	160	mW	
Junction temperature		Tj	110	°C	
Operating temperature range		T <sub>amb</sub>	-40 to +105	°C	
Storage temperature range		T <sub>stg</sub>	-40 to +110	°C	
Soldering temperature	According to reflow profile Fig. 9	T <sub>sd</sub>	260	°C	
Thermal resistance junction / ambient	JESD 51	$R_{thJA}$	270	K/W	

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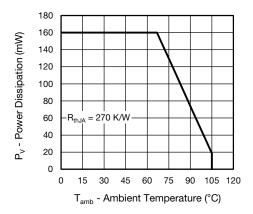


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

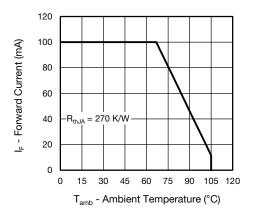


Fig. 2 - Forward Current Limit vs. Ambient Temperature

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	V <sub>F</sub>	1.15	1.35	1.6	V
	I <sub>F</sub> = 1 A, t <sub>p</sub> = 100 μs	$V_{F}$	-	2.2	-	V
Temperature coefficient of V <sub>F</sub>	I <sub>F</sub> = 1 mA	TK <sub>VF</sub>	=	-1.5	-	mV/K
	I <sub>F</sub> = 100 mA	TK <sub>VF</sub>	-	-1.1	-	mV/K
Reverse current	V <sub>R</sub> = 5 V	I <sub>R</sub>	-	-	10	μΑ
Junction capacitance	$V_R = 0 \text{ V, f} = 1 \text{ MHz,}$ $E = 0 \text{ mW/cm}^2$	CJ	=	70	-	pF
Radiant intensity	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	l <sub>e</sub>	3	6	12	mW/sr
	I <sub>F</sub> = 1 A, t <sub>p</sub> = 100 μs	l <sub>e</sub>	=	60	-	mW/sr
Radiant power	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	фе	-	40	-	mW
Temperature coefficient of radiant power	I <sub>F</sub> = 1 mA	TKφ <sub>e</sub>	-	-1.1	-	%/K
	I <sub>F</sub> = 100 mA	TKφ <sub>e</sub>	=	-0.51	-	%/K
Angle of half intensity		φ	-	± 60	-	deg
Peak wavelength	I <sub>F</sub> = 30 mA	$\lambda_{p}$	-	940	-	nm
Spectral bandwidth	I <sub>F</sub> = 30 mA	Δλ	-	25	-	nm
Temperature coefficient of $\lambda_p$	$I_F = 30 \text{ mA}$	$TK_{\lambda p}$	-	0.25	-	nm
Rise time	I <sub>F</sub> = 100 mA, 20 % to 80 %	t <sub>r</sub>	-	15	-	ns
Fall time	I <sub>F</sub> = 100 mA, 20 % to 80 %	t <sub>f</sub>	-	15	-	ns
Virtual source diameter		d	-	0.5	-	mm

### BASIC CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

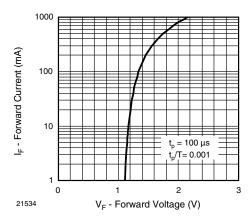


Fig. 3 - Forward Current vs. Forward Voltage

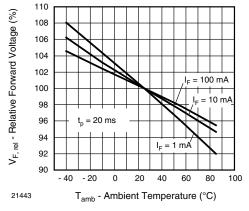


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

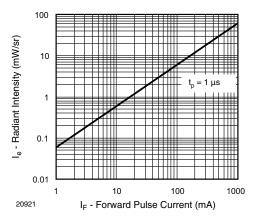


Fig. 5 - Radiant Intensity vs. Forward Current

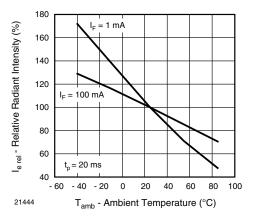


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

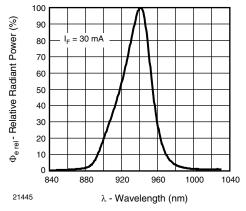


Fig. 7 - Relative Radiant Power vs. Wavelength

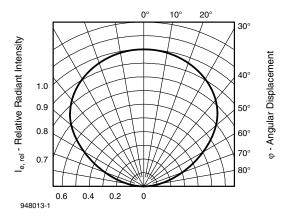


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement



#### **REFLOW SOLDER PROFIEL**

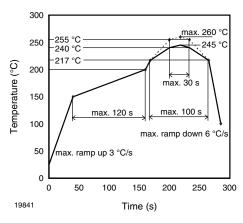


Fig. 9 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

#### **DRYPACK**

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

#### **FLOOR LIFE**

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

Moisture sensitivity: level 4

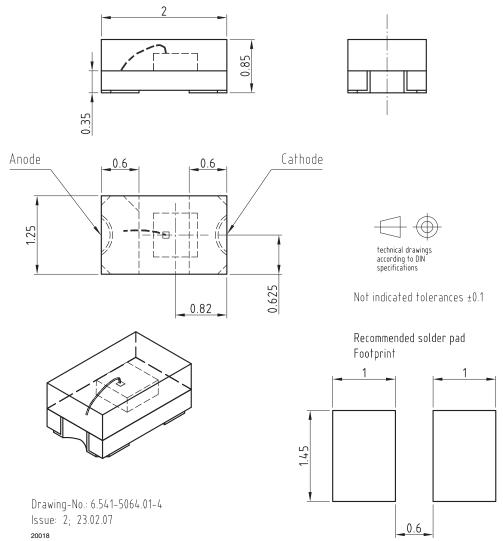
Floor life: 72 h

Conditions: T<sub>amb</sub> < 30 °C, RH < 60 %

#### **DRYING**

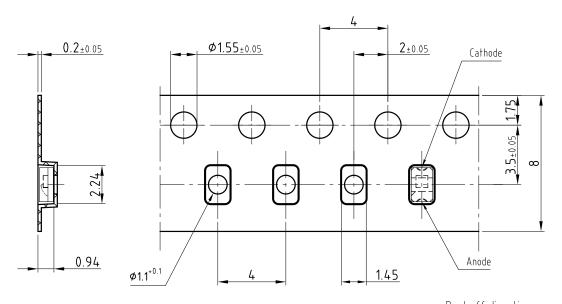
In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40  $^{\circ}$ C (+ 5  $^{\circ}$ C), RH < 5  $^{\circ}$ M.

#### **PACKAGE DIMENSIONS** in millimeters



ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000

#### **BLISTER TAPE DIMENSIONS** in millimeters



Reel off direction

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according to DIN specifications

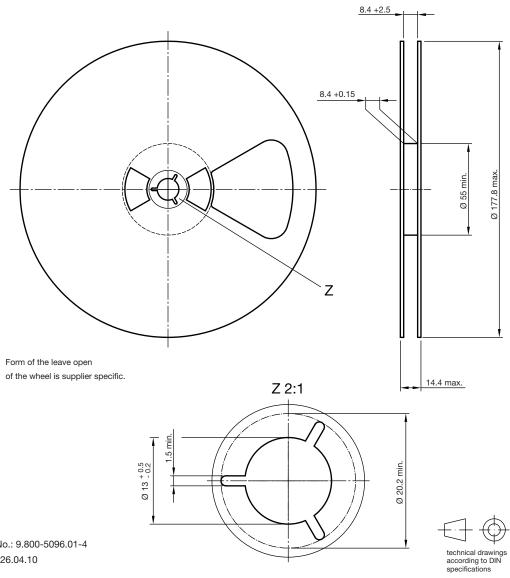
Drawing-No.: 9.700-5311.01-4

Issue: 1; 23.02.07

21501

Not indicated tolerances ±0.1

#### **REEL DIMENSIONS** in millimeters



Drawing-No.: 9.800-5096.01-4

Issue: 2; 26.04.10

20875



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